



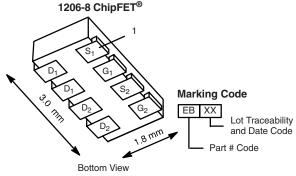
Complementary 20 V (D-S) MOSFET

PRODUCT SUMMARY							
	V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ.)			
N-Channel	20	0.075 at $V_{GS} = 4.5 \text{ V}$	4.2	4			
		0.134 at V _{GS} = 2.5 V	3.1	4			
P-Channel	- 20	$0.155 \text{ at V}_{GS} = -4.5 \text{ V}$	- 2.9	3			
		0.260 at $V_{GS} = -2.5 \text{ V}$	- 2.2	3			

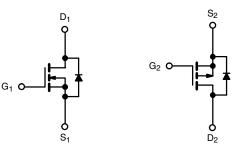
FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFETs
- Compliant to RoHS Directive 2002/95/EC





Ordering Information: Si5513DC-T1-E3 (Lead (Pb)-free) Si5513DC-T1-GE3 (Lead (Pb)-free and Halogen-free)



N-Channel MOSFET

P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted							
Parameter			N-Channel		P-Channel		
		Symbol	5 s	Steady State	5 s	Steady State	Unit
Drain-Source Voltage		V_{DS}	20		- 20		V
Gate-Source Voltage		V _{GS}	± 12				V
Continuous Dunin Comment /T 150 °C\d	T _A = 25 °C	- I _D	4.2	3.1	- 2.9	- 2.1	
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 85 °C		3.0	2.2	- 2.1	- 1.5	
Pulsed Drain Current		I _{DM}	10		- 10		Α
Continuous Source Current (Diode Conduction) ^a		I _S	1.8	0.9	- 1.8	- 0.9	
M	T _A = 25 °C	P _D	2.1	1.1	2.1	1.1	W
Maximum Power Dissipation ^a	T _A = 85 °C		1.1	0.6	1.1	0.6	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150				°C
Soldering Recommendations (Peak Temperature)b, c			260				°C

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient ^a	t ≤ 5 s	R _{thJA}	50	60	°C/W		
	Steady State		90	110			
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	30	40			

Notes:

- a. Surface mounted on 1" x 1" FR4 board.
- b. See reliability manual for profile. The ChipFET is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- c. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	-						ı
Cata Threehold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	N-Ch	0.6		1.5	V
Gate Threshold Voltage		V _{DS} = V _{GS} , I _D = - 250 μA	P-Ch	- 0.6		- 1.5	v
Gate-Body Leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ± 12 V	N-Ch			± 100	nA
			P-Ch			± 100	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 20 V, V _{GS} = 0 V	N-Ch			1	μΑ
		V _{DS} = - 20 V, V _{GS} = 0 V	P-Ch			- 1	
_o.o cate ronage _ram canom	555	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 70 \text{ °C}$ N-C				5	hm ,
		$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 70 \text{ °C}$	P-Ch			- 5	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	N-Ch	10			Α
		$V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	P-Ch	- 10			^
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 3.1 \text{ A}$	N-Ch		0.065	0.075	
		$V_{GS} = -4.5 \text{ V}, I_D = -2.1 \text{ A}$	P-Ch		0.130	0.155	Ω
		$V_{GS} = 2.5 \text{ V}, I_D = 2.3 \text{ A}$	N-Ch		0.115	0.134	52
		V _{GS} = - 2.5 V, I _D = - 1.7 A	P-Ch		0.215	0.260	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 10 V, I _D = 3.1 A	N-Ch		8		
		V _{DS} = - 10 V, I _D = - 2.1 A	P-Ch		5		S
	V _{SD}	I _S = 0.9 A, V _{GS} = 0 V	N-Ch		0.8	1.2	V
Diode Forward Voltage ^a		I _S = - 0.9 A, V _{GS} = 0 V	P-Ch		- 0.8	- 1.2	V
Dynamic ^b							
Total Gate Charge	Q _q	N.O.	N-Ch		4	6	
Total date onarge	G g	N-Channel $V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 3.1 \text{ A}$	P-Ch		3	6	nC
Gate-Source Charge	Q _{gs}	V _{DS} = 10 V, V _{GS} = 1.0 V, I _D = 0.1 / V	N-Ch		0.6		
		P-Channel	P-Ch		0.9		
Gate-Drain Charge	Q _{gd}	$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -2.1 \text{ A}$	N-Ch P-Ch		1.3 0.6		
			N-Ch		12	18	
Turn-On Delay Time	t _{d(on)}	N-Channel	P-Ch		13	20	
D: T:		$V_{DD} = 10 \text{ V}, R_L = 10 \Omega$	N-Ch		35	55	
Rise Time		$I_D \cong$ 1 A, V_{GEN} = 4.5 V, R_g = 6 Ω	P-Ch		35	55	
Turn-Off Delay Time	t _{d(off)}	P-Channel	N-Ch		19	30	
Tarri On Delay Time		$V_{DD} = -10 \text{ V}, R_L = 10 \Omega$	P-Ch		25	40	ns -
Fall Time	t _f	$I_D\cong$ - 1 A, $V_{GEN}=$ - 4.5 V, $R_g=$ 6 Ω	N-Ch		9	15	
			P-Ch		25	40	
Source-Drain Reverse Recovery Time	t _{rr} -	I _F = 0.9 A, dI/dt = 100 A/μs	N-Ch		40	80	
		I _F = - 0.9 A, dl/dt = 100 A/μs	P-Ch		40	80	

Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

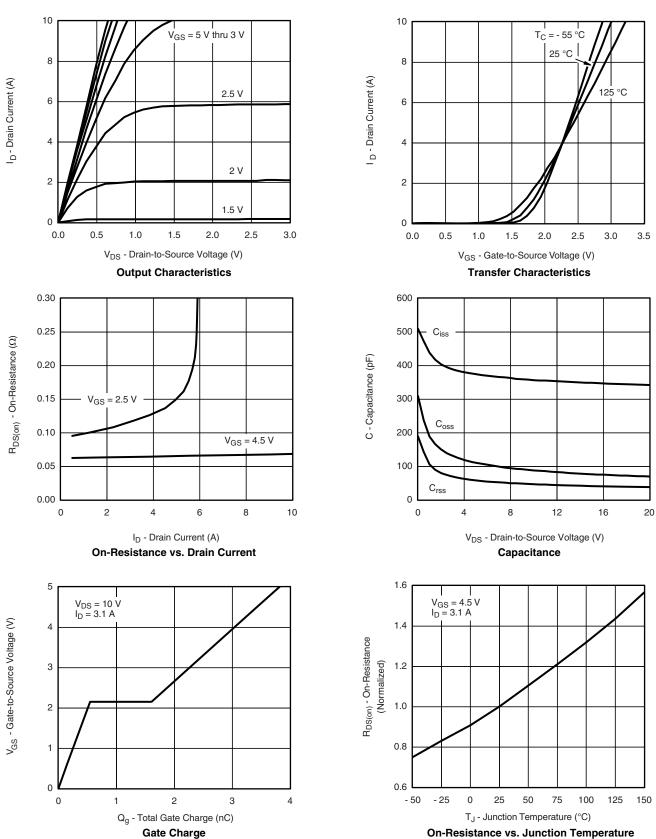
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.







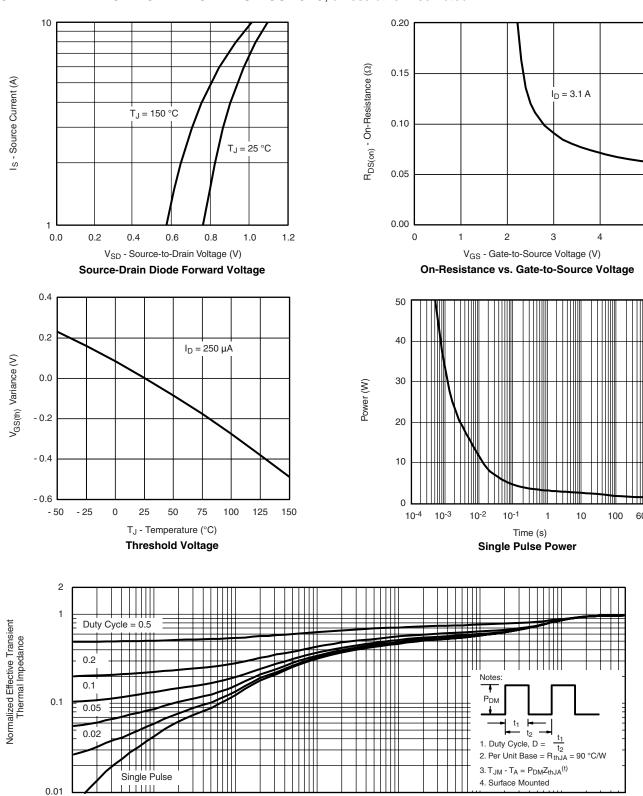
N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



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N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



10⁻¹

10-4

10-3

10⁻²

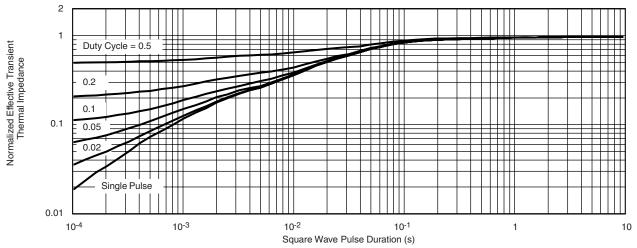
600

100

10

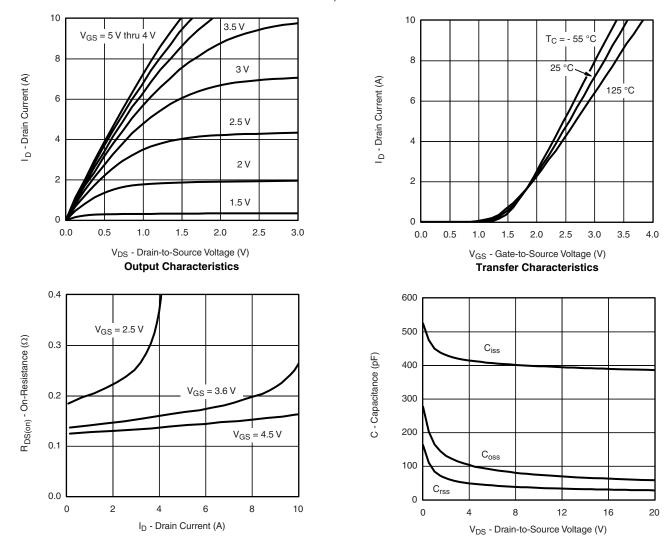


N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



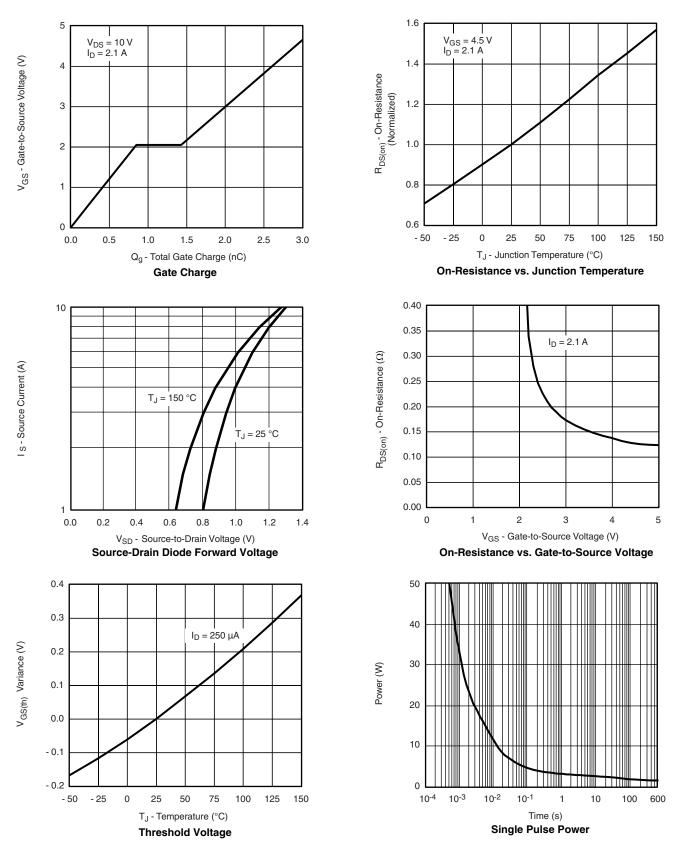
On-Resistance vs. Drain Current

Capacitance

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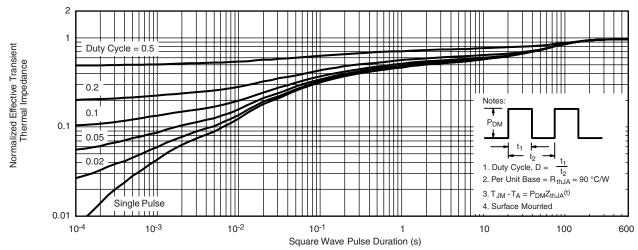


P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

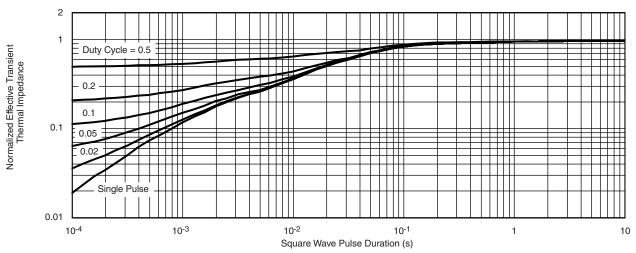




P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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